

Final datasheet

The Soft 650 V Emitter Controlled Si Diode 7 offers improved reliability for both Industrial and Home Appliance applications

Features

- $V_{RRM} = 650\text{ V}$
- $I_F = 150\text{ A}$
- Low and temperature stable forward voltage (V_F)
- Very soft and fast recovery
- Low reverse recovery current (I_{rrm})
- Humidity robust design
- Cosmic ray ruggedness
- Maximum junction temperature $T_{vjmax} = 175^\circ\text{C}$
- Qualified according to JEDEC for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models: <http://www.infineon.com/ec7/>

Potential applications

- String and micro inverter
- Datacenter UPS
- Offline UPS/Residential UPS
- Online UPS/Industrial UPS
- Residential aircon
- Welding

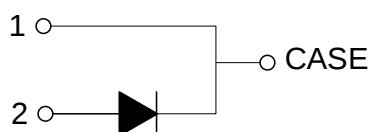
Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

Description

Pin definition:

- Pin 1 and backside - Cathode
- Pin 2 - Anode



Type	Package	Marking
IDWD150E65E7	PG-TO247-2-STD-NA8.8	E150EE7



Table of contents

	Description	1
	Features	1
	Potential applications	1
	Product validation	1
	Table of contents	2
1	Package	3
2	Diode	3
3	Characteristics diagrams	6
4	Package outlines	8
5	Testing conditions	9
	Revision history	10
	Disclaimer	11

1 Package

1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting processes: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$				0.33	K/W

2 Diode

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25\text{ °C}$		650	V
Diode forward current, limited by T_{vjmax}	I_F	limited by bondwire	$T_c = 25\text{ °C}$	200	A
			$T_c = 100\text{ °C}$	153	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}			600	A
Diode surge non repetitive forward current, sine halfwave	I_{FSM}	$t_p = 10\text{ ms}$	$T_c = 25\text{ °C}$	600	A
Power dissipation	P_{tot}		$T_c = 25\text{ °C}$	453	W
			$T_c = 100\text{ °C}$	227	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode forward voltage	V_F	$I_F = 150\text{ A}$	$T_{vj} = 25\text{ °C}$		1.65	2.1	V
			$T_{vj} = 125\text{ °C}$		1.6		
			$T_{vj} = 175\text{ °C}$		1.55		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Reverse leakage current	I_R	$V_R = 650 \text{ V}$	$T_{vj} = 25 \text{ °C}$			20	μA
			$T_{vj} = 175 \text{ °C}$		1160		
Diode reverse recovery time	t_{rr}	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		97		ns
			$T_{vj} = 25 \text{ °C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		88.3		
			$T_{vj} = 175 \text{ °C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		175		
			$T_{vj} = 175 \text{ °C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		148		
Diode reverse recovery charge	Q_{rr}	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		2.16		μC
			$T_{vj} = 25 \text{ °C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		1.75		
			$T_{vj} = 175 \text{ °C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		6.4		
			$T_{vj} = 175 \text{ °C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		5.2		
Diode peak reverse recovery current	I_{rrm}	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		33.4		A
			$T_{vj} = 25 \text{ °C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		27.8		
			$T_{vj} = 175 \text{ °C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		56.3		
			$T_{vj} = 175 \text{ °C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		52		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ }^{\circ}\text{C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		1500		$\text{A}/\mu\text{s}$
			$T_{vj} = 25 \text{ }^{\circ}\text{C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		1500		
			$T_{vj} = 175 \text{ }^{\circ}\text{C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		1160		
			$T_{vj} = 175 \text{ }^{\circ}\text{C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		1720		
Reverse recovery energy	E_{rec}	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ }^{\circ}\text{C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		0.29		mJ
			$T_{vj} = 25 \text{ }^{\circ}\text{C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		0.23		
			$T_{vj} = 175 \text{ }^{\circ}\text{C}$, $I_F = 150 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		0.99		
			$T_{vj} = 175 \text{ }^{\circ}\text{C}$, $I_F = 75 \text{ A}$, $-di_F/dt = 1000 \text{ A}/\mu\text{s}$		0.81		
Operating junction temperature	T_{vj}			-40		175	$^{\circ}\text{C}$

Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

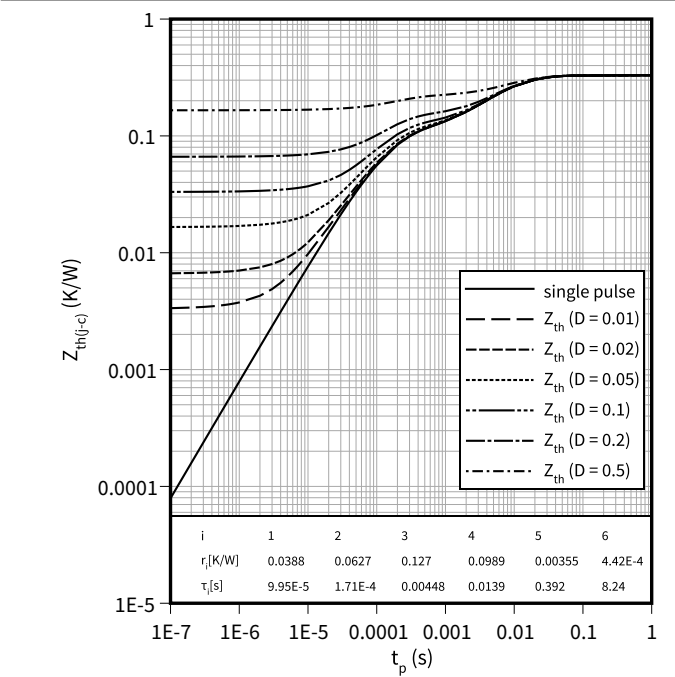
Electrical Characteristic at $T_{vj} = 25^{\circ}\text{C}$, unless otherwise specified.

Dynamic test circuit, parasitic inductance $L_{\sigma} = 30 \text{ nH}$, parasitic capacitor $C_{\sigma} = 18 \text{ pF}$ from Fig. E.

3 Characteristics diagrams

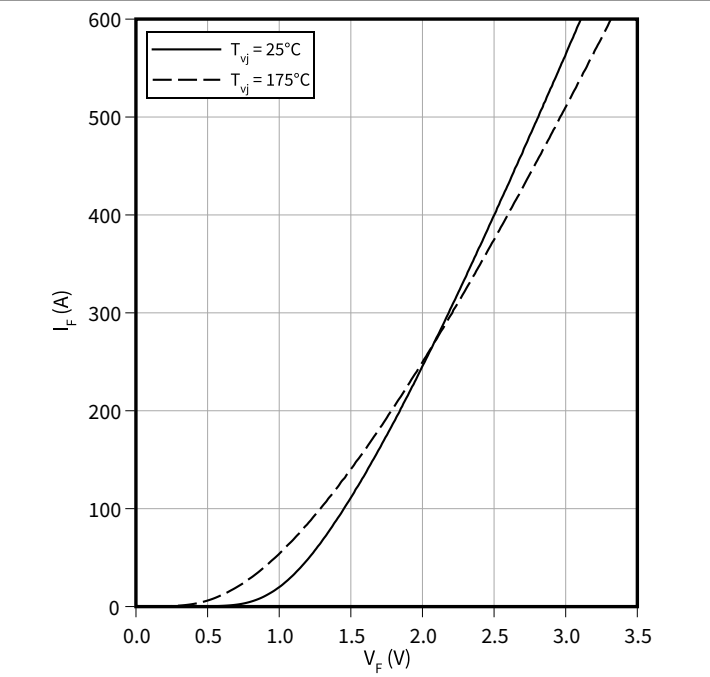
Diode transient thermal impedance as a function of pulse width

$Z_{th(j-c)} = f(t_p)$
 $D = t_p/T$



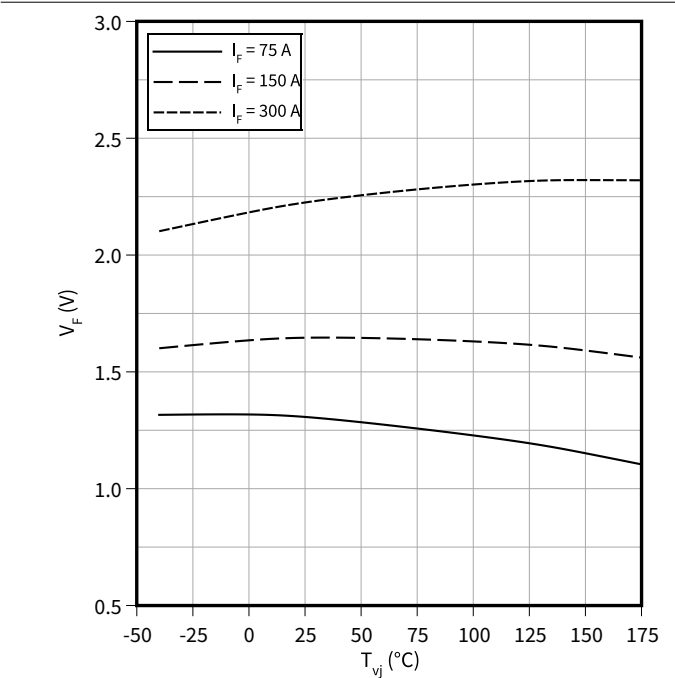
Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$



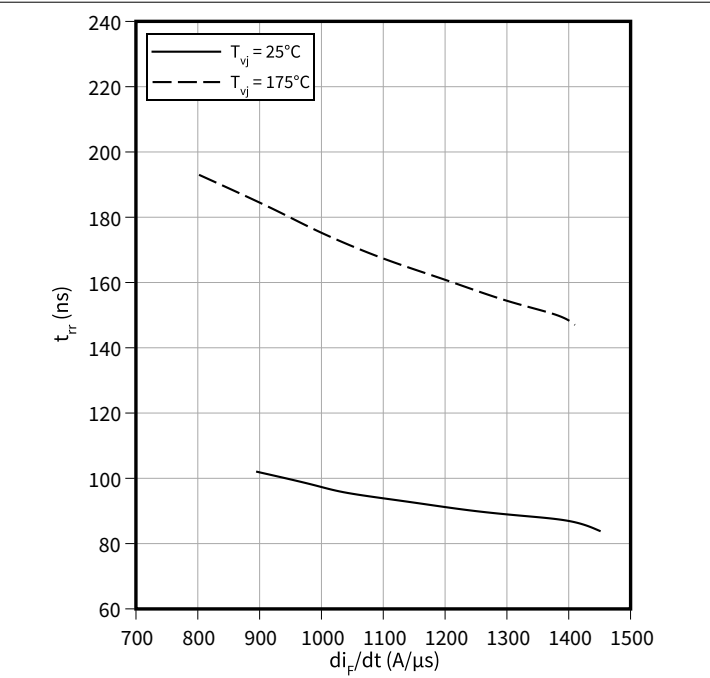
Typical diode forward voltage as a function of junction temperature

$V_F = f(T_{vj})$



Typical reverse recovery time as a function of diode current slope

$t_{rr} = f(di_F/dt)$
 $V_R = 400\text{ V}, I_F = 150\text{ A}$

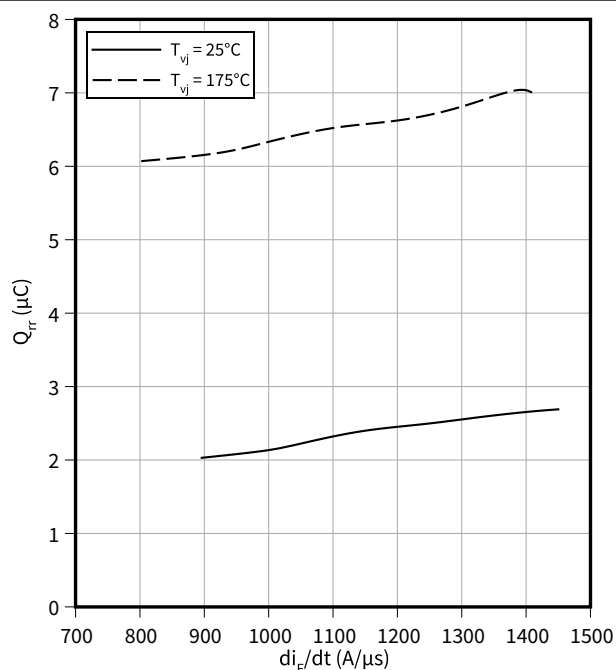


3 Characteristics diagrams

Typical reverse recovery charge as a function of diode current slope

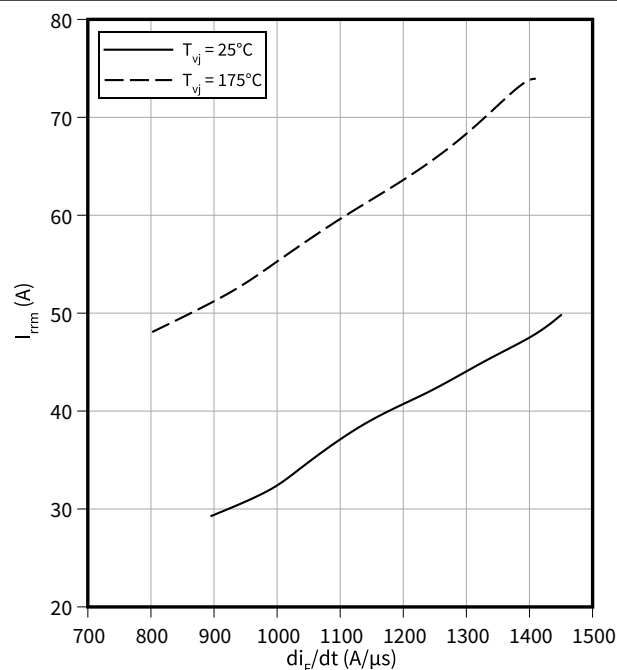
$$Q_{rr} = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 150 \text{ A}$$

**Typical reverse recovery current as a function of diode current slope**

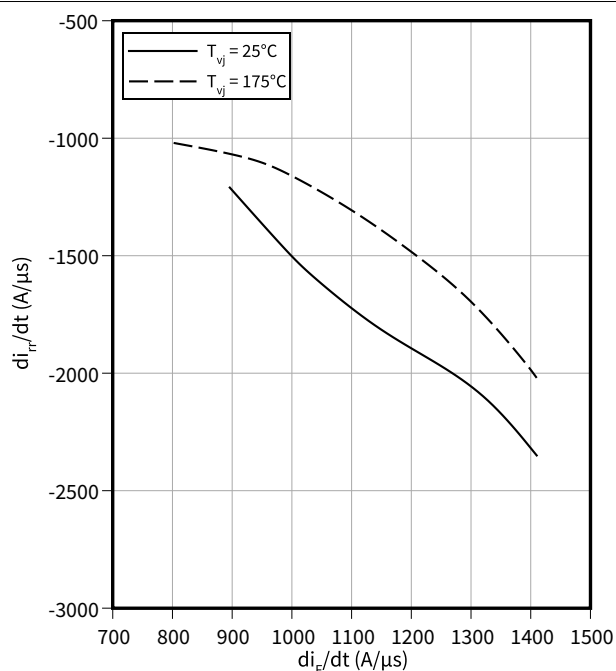
$$I_{rrm} = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 150 \text{ A}$$

**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope**

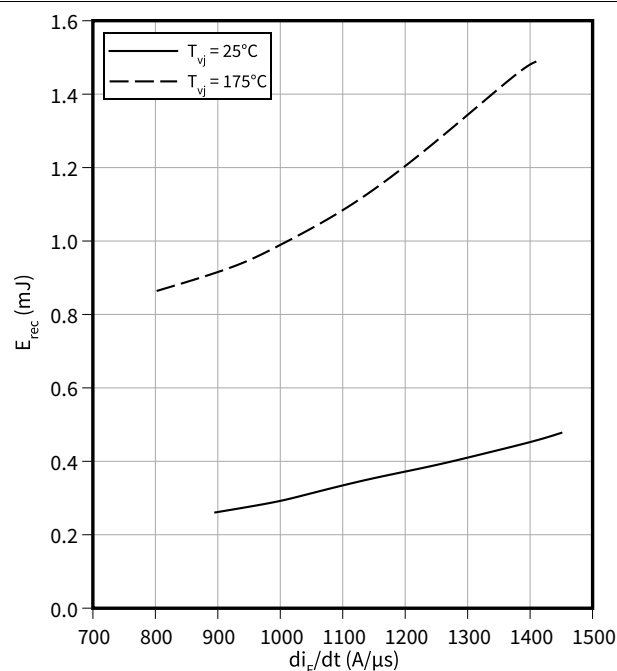
$$di_{rr}/dt = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 150 \text{ A}$$

**Typical reverse energy losses as a function of diode current slope**

$$E_{rec} = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 150 \text{ A}$$



4 Package outlines

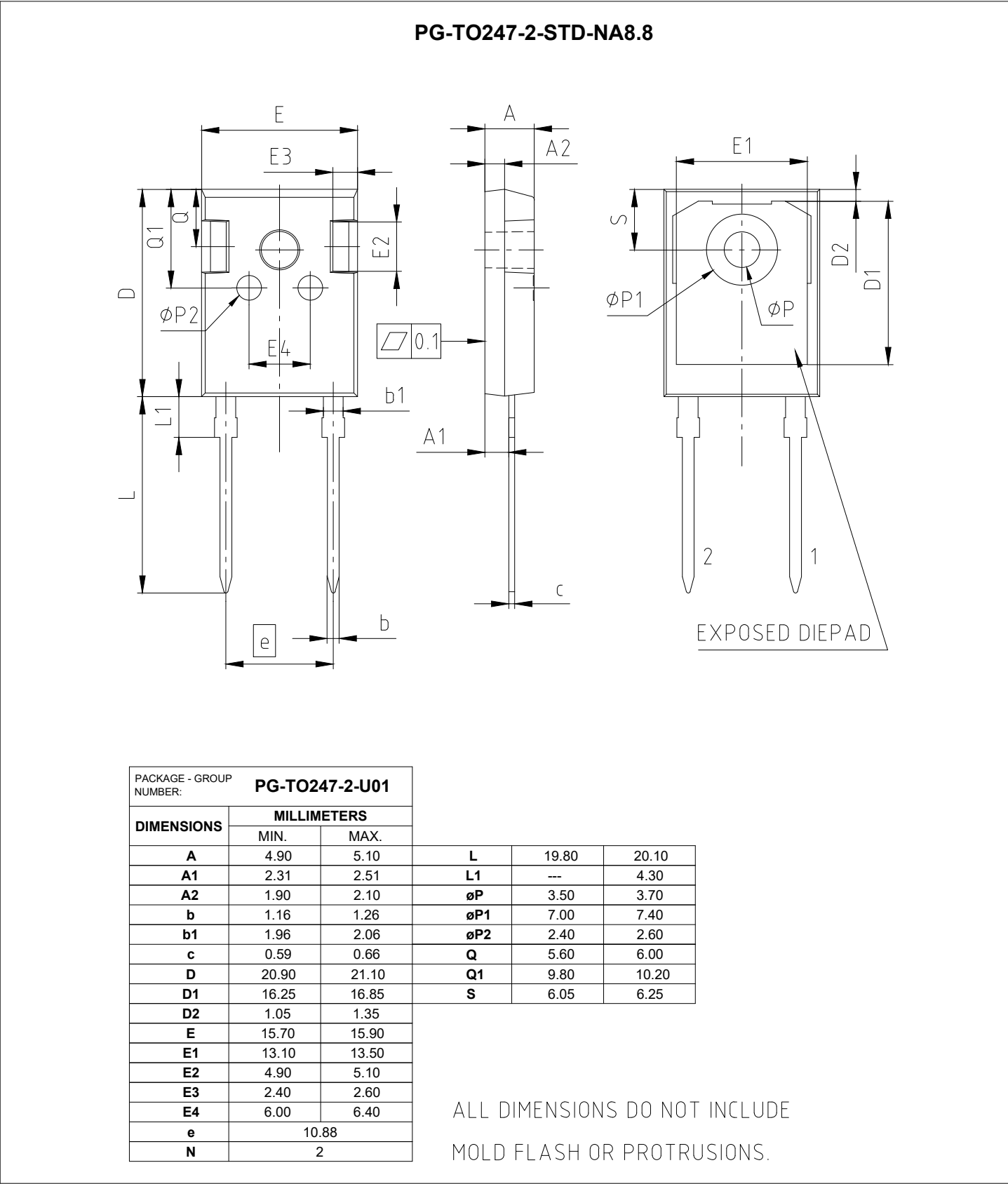


Figure 1

5 Testing conditions

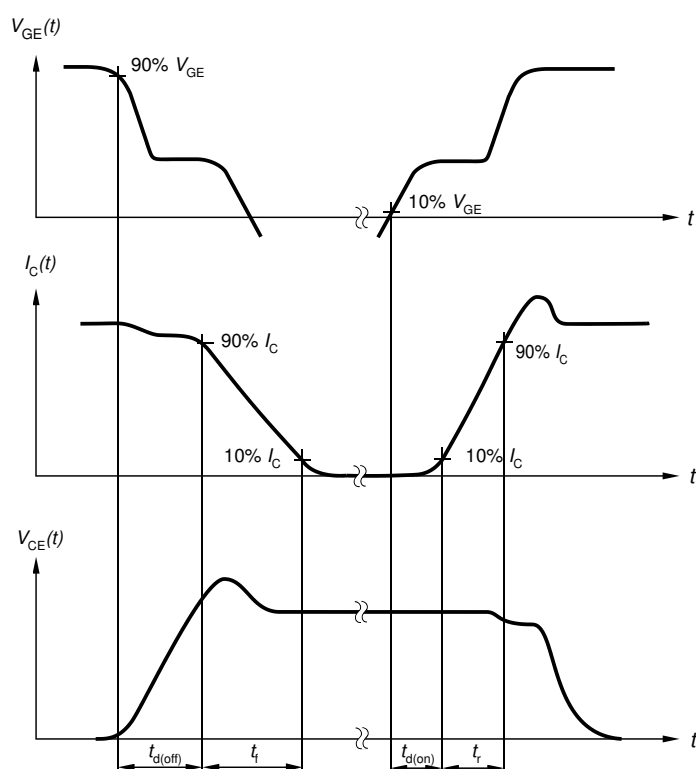


Figure A. Definition of switching times

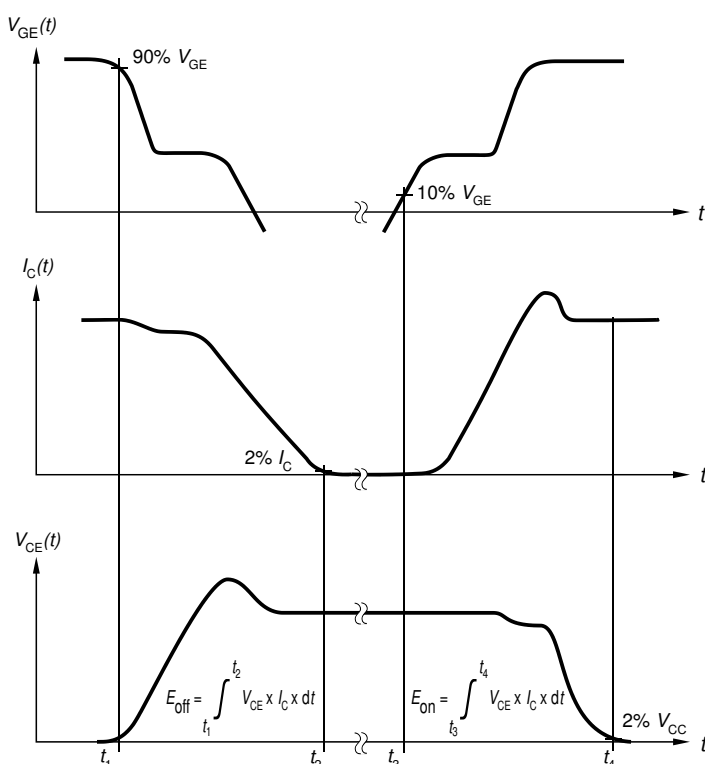


Figure B. Definition of switching losses

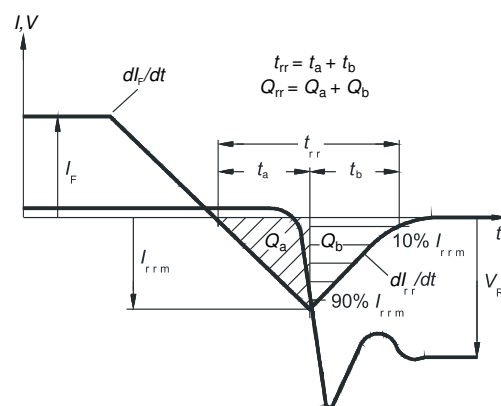


Figure C. Definition of diode switching characteristics

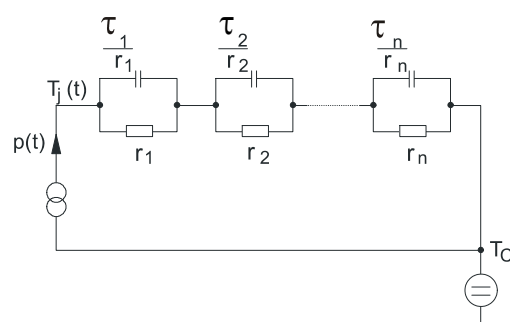


Figure D. Thermal equivalent circuit

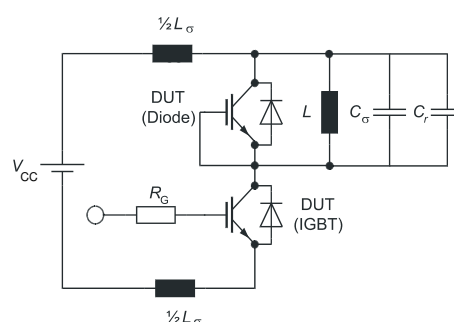


Figure E. **Dynamic test circuit**
Parasitic inductance L_σ ,
parasitic capacitor C_σ ,
relief capacitor C_r ,
(only for ZVT switching)

Revision history

Document revision	Date of release	Description of changes
0.10	2023-04-26	Preliminary datasheet
1.00	2023-05-02	Final datasheet
1.10	2023-11-06	Update of diode forward current I_F Update of graph on page 6

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

Edition 2023-11-06

Published by

Infineon Technologies AG
81726 Munich, Germany

© 2023 Infineon Technologies AG
All Rights Reserved.

Do you have a question about any aspect of this document?

Email: erratum@infineon.com

Document reference
IFX-ABG821-003

Important notice

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffenhheitsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Please note that this product is not qualified according to the AEC Q100 or AEC Q101 documents of the Automotive Electronics Council.

Warnings

Due to technical requirements products may contain dangerous substances. For information on the types in question please contact your nearest Infineon Technologies office.

Except as otherwise explicitly approved by Infineon Technologies in a written document signed by authorized representatives of Infineon Technologies, Infineon Technologies' products may not be used in any applications where a failure of the product or any consequences of the use thereof can reasonably be expected to result in personal injury.